

JTMA7037A/B

8-PIN Synchronous Buck PWM Controller

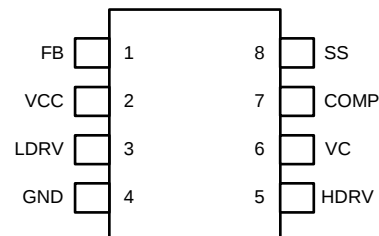
Features

- Operating with Single 5V or 12V Input
- Drives N-Channel MOSFETs
- Simple Single-Loop Control Design
 - Voltage-Mode PWM Control
 - Full 0% to 100% Duty Ratio
 - Fast Transient Response
- $\pm 2\%$ Output Voltage Accuracy Over Temperature
- Under-Voltage Protection for Output
- 200/400kHz Constant Frequency Operation
 - 200kHz for JTMA7037B
 - 400kHz for JTMA7037A
- Small size, 8-PIN Package (SOIC or TSSOP)
- Lead Free and Green Devices Available (RoHS Compliant)

General Description

The JTMA7037 series are designed to provide a low cost synchronous Buck regulator for on-board DC to DC converter applications. The JTMA7037 series together with dual N-channel MOSFETs such as APM7313, provide a low cost solution for such applications. Each device features an internal 200/400kHz oscillator, Power-On-Reset (POR) for both VCC and VC supplies, an external programmable soft-start function as well as output under-voltage detection that latches off the device when an output short is detected.

Pin Configuration



Applications

- Graphics Cards
- DDR Memory Power Supply
- DDR Memory Termination Voltage
- Low-Voltage Distributed Power Supplies

JIATAIMU reserves the right to make changes to improve reliability or manufacturability without notice, and advise customers to obtain the latest version of relevant information to verify before placing orders.

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Ordering and Marking Information

JTMA7037A/B	Assembly Material	Package Code	K : SOP-8	O : TSSOP-8
	Handling Code	Operating Junction Temperature Range	C : 0 to 70 C°	
	Temperature Range	Handling Code	TR : Tape & Reel	
	Package Code	Assembly Material	L : Lead Free Device	
			G : Halogen and Lead Free Device	
JTMA7037A/B K :	JTMA7037A/B XXXXX	XXXXX - Date Code		
JTMA7037A/B O :	JTMA7037A/B XXXXX	XXXXX - Date Code		

Note : JIATAIMU lead-free products contain molding compounds/die attach materials and 100% matte tin plate termination finish; which are fully compliant with RoHS. JIATAIMU lead-free products meet or exceed the lead-free requirements of IPC/JEDEC J-STD-020C for MSL classification at lead-free peak reflow temperature. JIATAIMU defines "Green" to mean lead-free (RoHS compliant) and halogen free (Br or Cl does not exceed 900ppm by weight in homogeneous material and total of Br and Cl does not exceed 1500ppm by weight).

Absolute Maximum Ratings

Symbol	Parameter	Rating	Unit
V _{CC}	VCC to GND	-0.2~30	V
V _C	VC to GND	-0.2~30	V
T _J	Operating Junction Temperature	0~125	°C
T _{STG}	Storage Temperature	-65~150	°C
T _{SDR}	Maximum Lead Soldering Temperature, 10 Seconds	260	°C

Thermal Characteristics

Symbol	Parameter	Typical Value	Unit
θ _{JA}	Thermal Resistance in Free Air	160	°C/W
	SOP-8	124	
	TSSOP-8		

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Electrical Characteristics

Unless otherwise specified, these specifications apply over $V_{CC}=5V$, $V_C=12V$ and $T_A=0$ to $70^{\circ}C$. Typical values refer to $T_A=25^{\circ}C$.

Symbol	Parameter	Test Conditions	JTMA7037/A/B			Unit
			Min.	Typ.	Max.	
SUPPLY CURRENT						
ICC	VCC Dynamic Supply Current	FOSC=200kHz, CL=1500pF	2	3	5	mA
IC	VC Dynamic Supply Current	FOSC=200kHz, CL=1500pF	2	5.5	8	mA
ICCQ	VCC Static Supply Current	SS=GND	0.5	1.5	3	mA
ICQ	VC Static Supply Current	SS=GND	0.2	0.4	1	mA
POWER-ON-RESET						
	Rising VCC Threshold		4.0	4.2	4.4	V
	VCC POR Hysteresis		-	0.25	-	V
	Rising VC Threshold		3.1	3.3	3.5	V
	VC POR Hysteresis		-	0.2	-	V
OSCILLATOR						
FOSC	Free Running Frequency	JTMA7037A JTMA7037B	360 180	400 200	440 220	kHz
□Vosc	Ramp Amplitude		-	1.10	-	V
ERROR AMPLIFIER						
IFB1	FB Pin Input Bias Current	SS=3V, VFB=1V	-	1	-	nA
IFB2	FB Pin Input Bias Current	SS=0V, VFB=1V	-	-64	-	∞A
GM	Transconductance		450	600	750	∞mho
REFERENCE VOLTAGE						
VFB	FB Pin Regulation Voltage	JTMA7037A JTMA7037B	0.784 0.784	0.800 0.800	0.816 0.816	V
LREG	VFB Line Regulation	VCC = 5~12V	-	0.2	0.35	%
GATE DRIVERS						
	HDRV Rising Time	CL = 1500pF	-	20	50	nS
	HDRV Falling Time	CL = 1500pF	-	15	50	nS
	LDRV Rising Time	CL = 1500pF	-	25	50	nS
	LDRV Falling Time	CL = 1500pF	-	25	50	nS
	Dead Band Time		50	150	250	nS
PROTECTION						
VFBUV	FB Under-Voltage Threshold	VFB Falling JTMA7037A JTMA7037B	0.3 0.3	0.4 0.4	0.5 0.5	V
VSD	Shutdown Threshold Voltage	Pull the voltage of SS pin	-	0.5	-	V
ISS	Soft-Start Current	SS=0	10	20	30	∞A

Function Pin Description

FB (Pin 1)

Connect this pin to the output (VOUT) of the PWM converter via an external resistor divider to provide a voltage feedback path for the converter. The output voltage set by the resistor divider is determined using the following formula :

$$V_{OUT} = V_{REF} \times \left(1 + \frac{R_{OUT}}{R_{GND}} \right)$$

where ROUT is the resistor connected from VOUT to FB , and RGND is the resistor connected from FB to ground. The voltage at this pin is also monitored for Under-Voltage protection.

VCC (Pin 2)

Connect this pin to input voltage from 5V to 20V. This pin provides the bias for the control circuitry and the low-side power MOSFET driver (LDRV). The voltage at this pin is monitored for Power-On-Reset (POR) purpose.

LDRV (Pin 3)

Connect this pin to the gate of the low-side power MOSFET. This pin provides the gate drive for the MOSFET.

GND (Pin 4)

Signal and power ground for the IC. All voltage levels are measured with respect to this pin.

HDRV (Pin 5)

Connect this pin to the gate of the high-side power MOSFET. This pin provides the gate drive for the MOSFET.

VC (Pin 6)

This pin provides bias voltage to the high-side MOSFET driver. A bootstrap circuit may be used to pump a boot voltage for enforcing the driving capability of the gate driver and improving the performance of the MOSFET.

COMP (Pin 7)

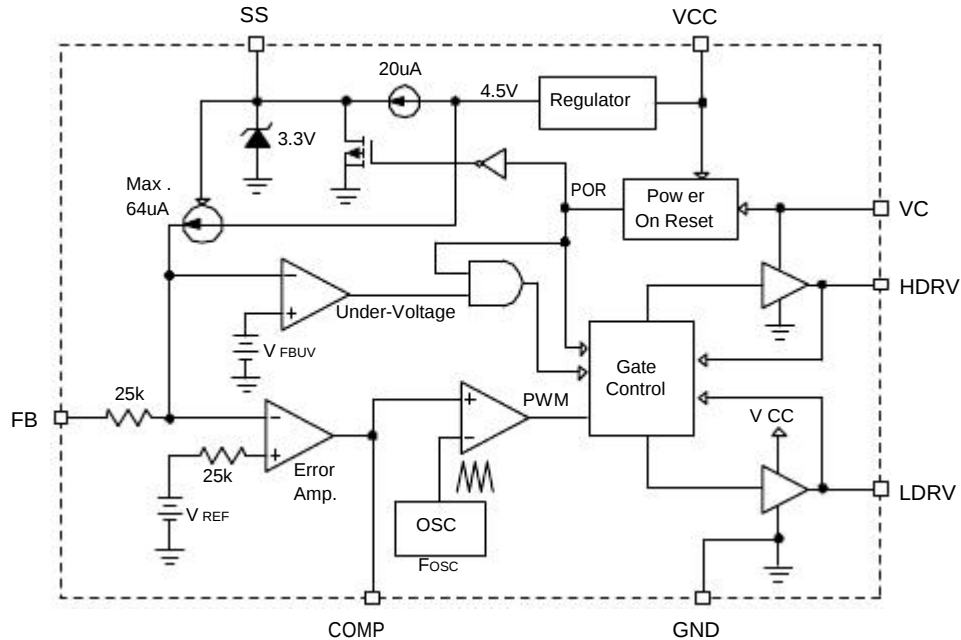
This pin is the output of the error amplifier. Add an external resistor-capacitor network to provide a loop compensation for the PWM converter.

SS (Pin 8)

Connect a capacitor from this pin to ground. This capacitor, along with an internal 20 μ A current source, sets the soft-start interval of the PWM converter and prevents the outputs from overshoot as well as limits the input current. Pull this pin below 0.5V can shutdown the converter.

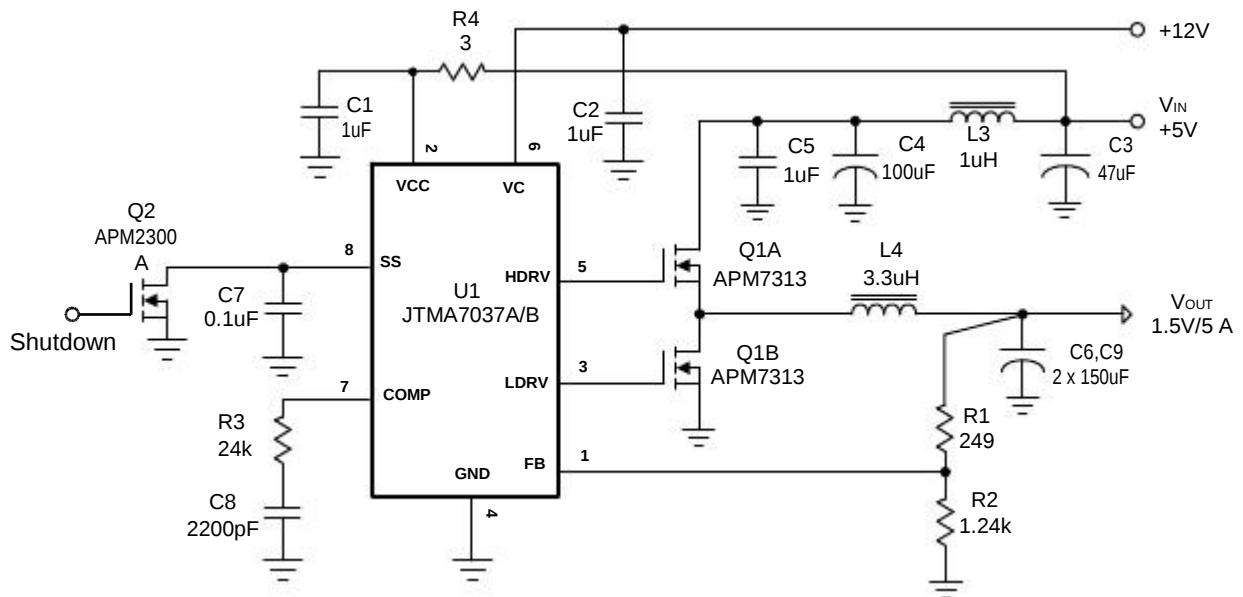
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Block Diagram



Typical Application Circuit

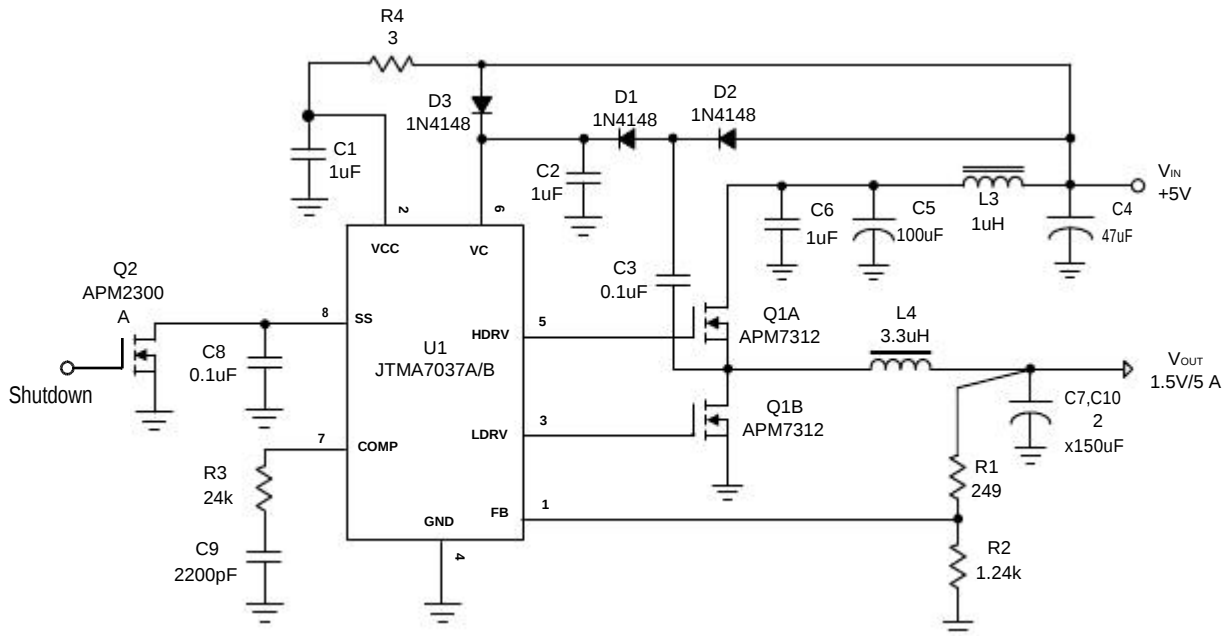
1. Dual supply voltage(5V and 12V) application



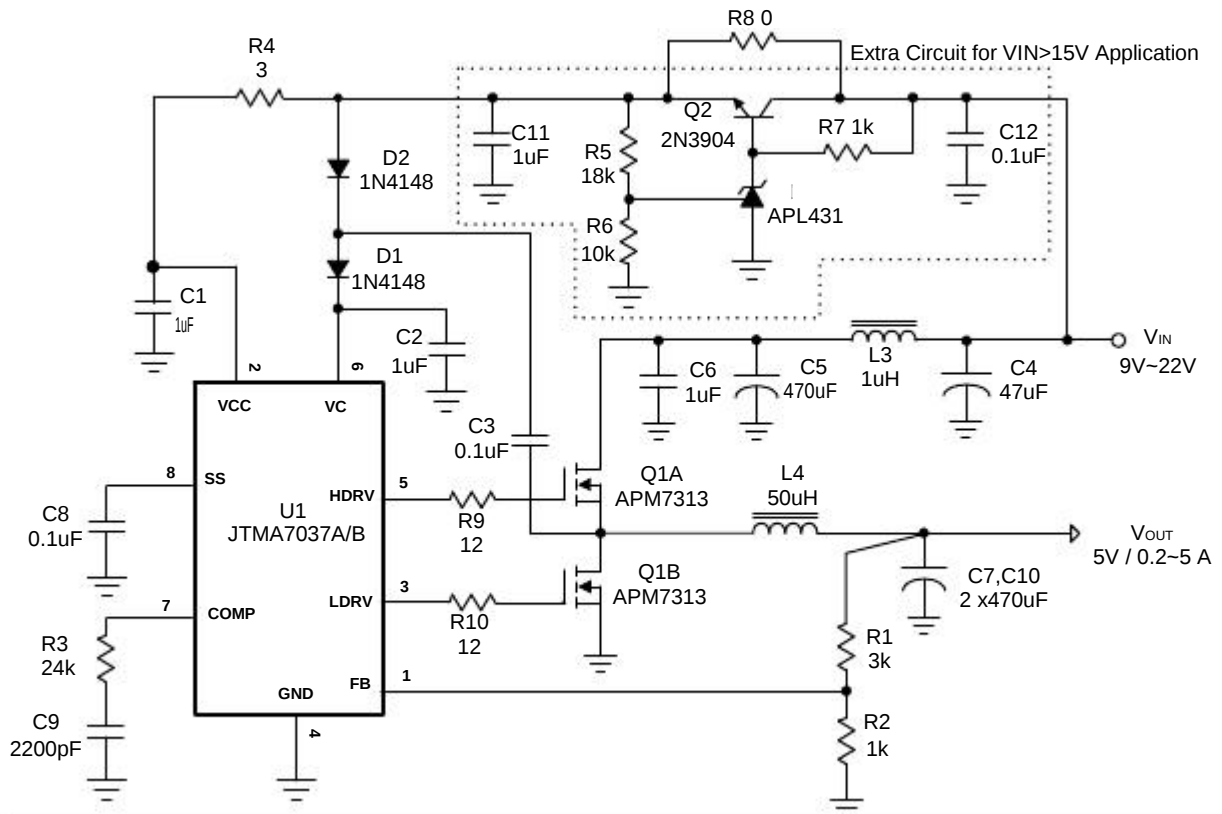
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Typical Application Circuit (Cont.)

2. Single supply voltage(5V) application



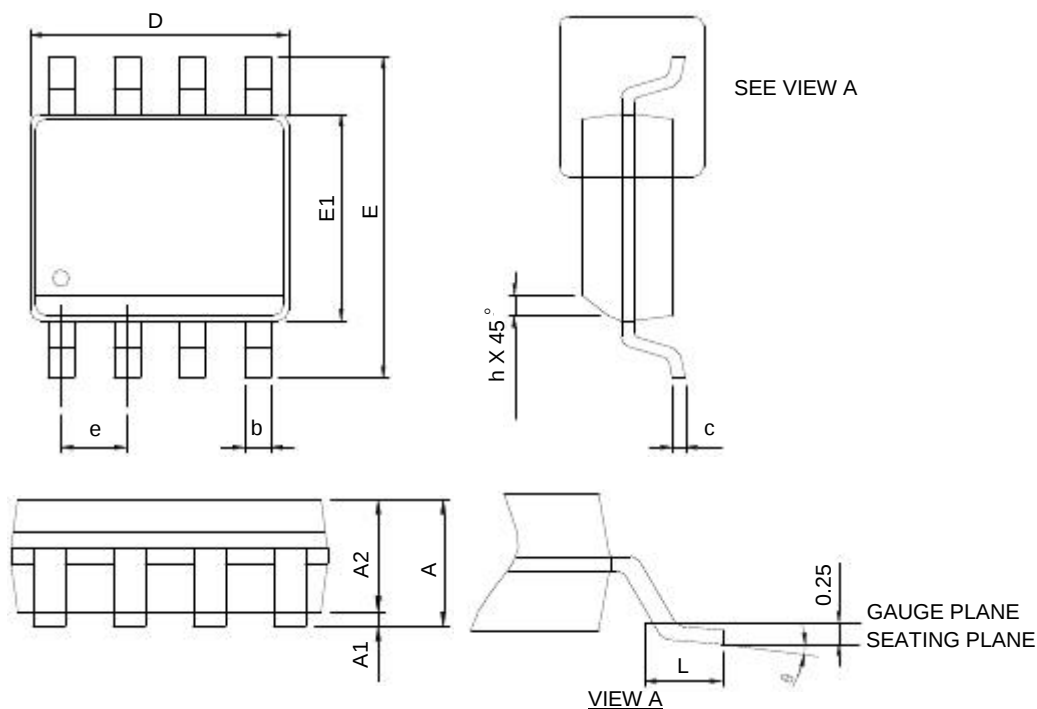
3. LCD Monitor Application Circuit



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Package Information

SOP-8



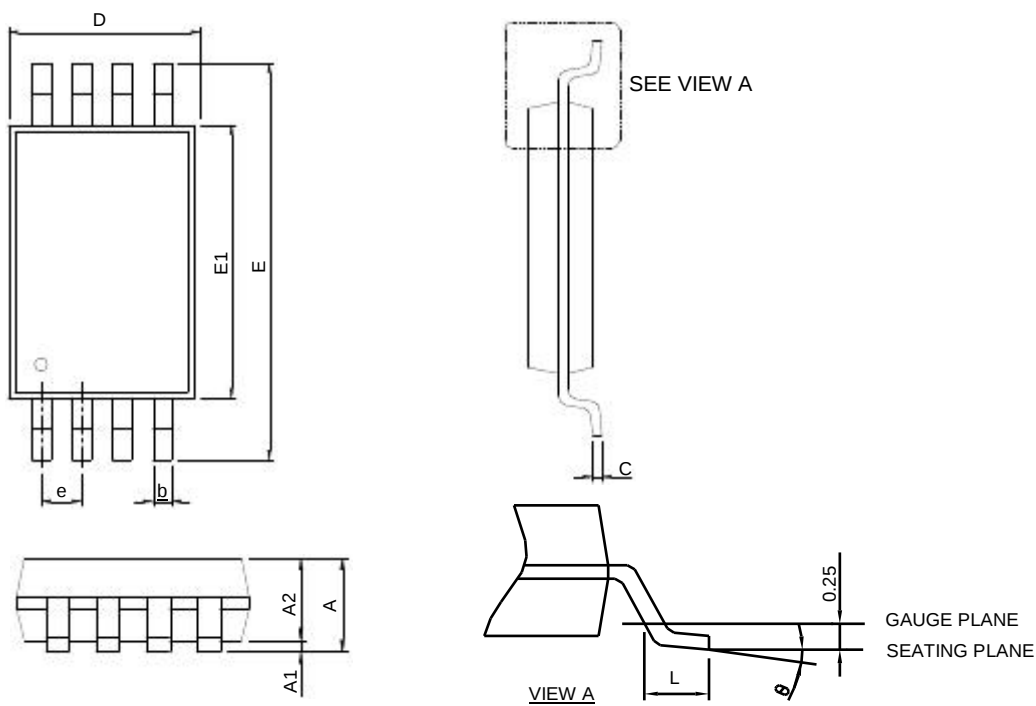
SYMBOL	SOP-8			
	MILLIMETERS		INCHES	
	MIN.	MAX.	MIN.	MAX.
A		1.75		0.069
A1	0.10	0.25	0.004	0.010
A2	1.25		0.049	
b	0.31	0.51	0.012	0.020
c	0.17	0.25	0.007	0.010
D	4.80	5.00	0.189	0.197
E	5.80	6.20	0.228	0.244
E1	3.80	4.00	0.150	0.157
e	1.27 BSC		0.050 BSC	
h	0.25	0.50	0.010	0.020
L	0.40	1.27	0.016	0.050
0	0°	8°	0°	8°

- Note: 1. Follow JEDEC MS-012 AA.
 2. Dimension "D" does not include mold flash, protrusions or gate burrs.
 Mold flash, protrusion or gate burrs shall not exceed 6 mil per side.
 3. Dimension "E" does not include inter-lead flash or protrusions.
 Inter-lead flash and protrusions shall not exceed 10 mil per side.

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Package Information

TSSOP-8

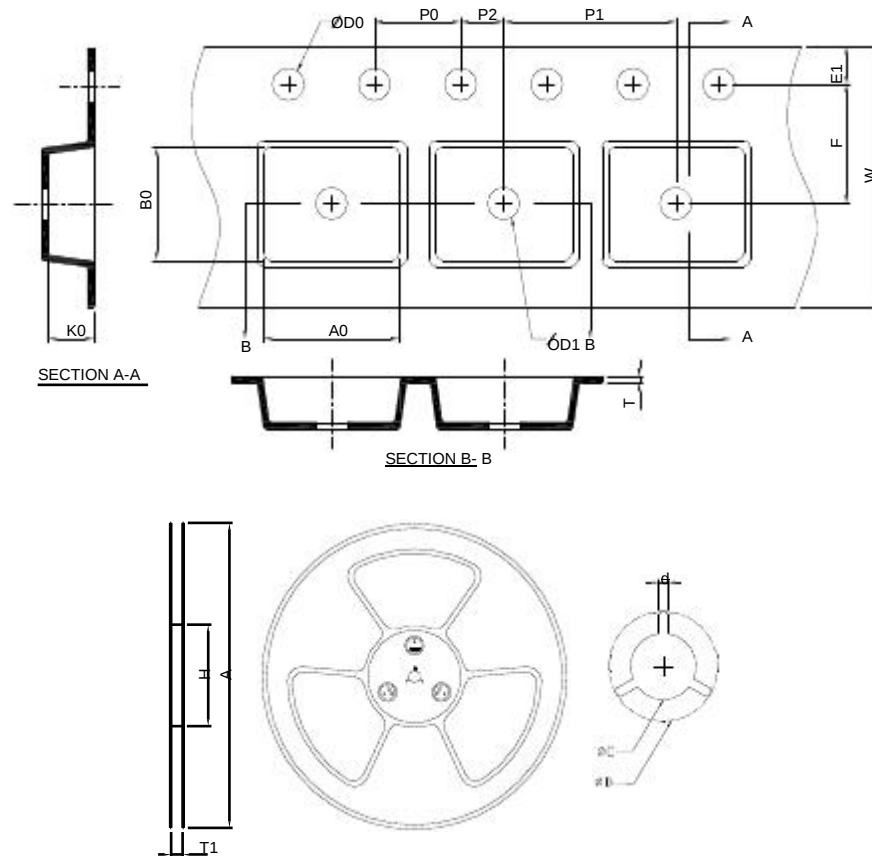


SYMBOL	TSSOP-8			
	MILLIMETERS		INCHES	
	MIN.	MAX.	MIN.	MAX.
A		1.20		0.047
A1	0.05	0.15	0.002	0.006
A2	0.80	1.05	0.031	0.041
b	0.19	0.30	0.007	0.012
c	0.09	0.20	0.004	0.008
D	2.90	3.10	0.114	0.122
E	6.20	6.60	0.244	0.260
E1	4.30	4.50	0.169	0.177
e	0.65 BSC		0.026 BSC	
L	0.45	0.75	0.018	0.030
θ	0 °	8 °	0 °	8 °

- Note : 1. Follow JEDEC MO-153 AA
 2. Dimension "D" does not include mold flash, protrusions or gate burrs. Mold flash, protrusion or gate burrs shall not exceed 6 mil per side.
 3. Dimension "E1" does not include inter-lead flash or protrusions. Inter-lead flash and protrusions shall not exceed 10 mil per side.

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Carrier Tape & Reel Dimensions



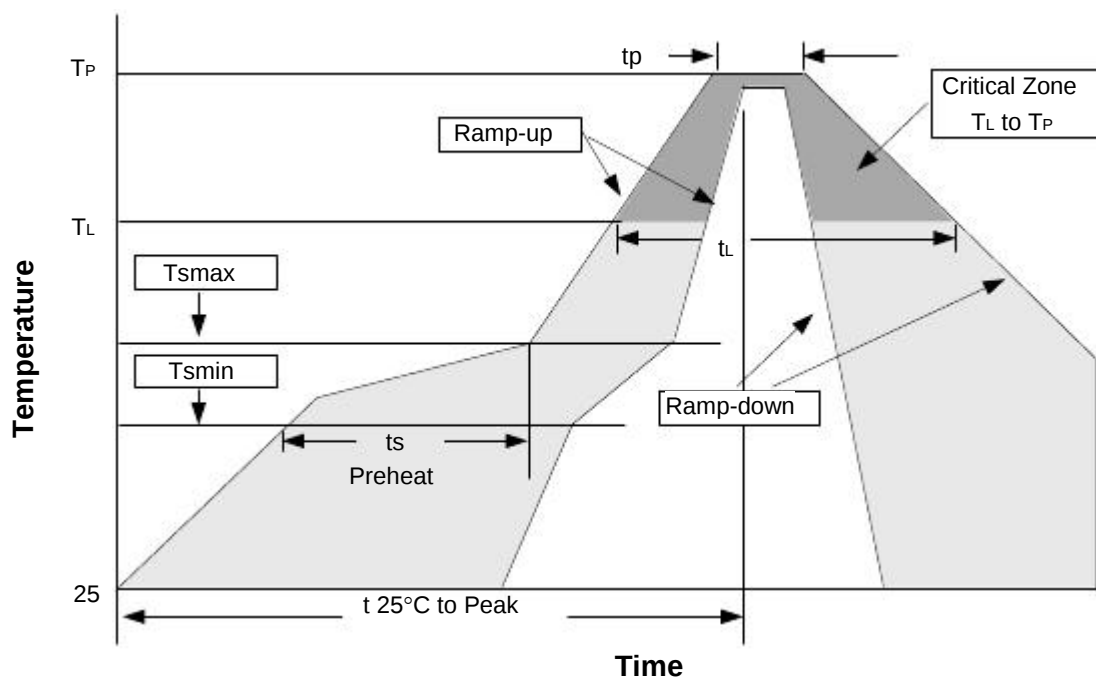
Application	A	H	T1	C	d	D	W	E1	F
SOP-8	330.0±2.00	50 MIN.	12.4+2.00 -0.00	13.0+0.50 -0.20	1.5 MIN.	20.2 MIN.	12.0±0.30	1.75±0.10	5.5±0.05
	P0	P1	P2	D0	D1	T	A0	B0	K0
	4.0±0.10	8.0±0.10	2.0±0.05	1.5+0.10 -0.00	1.5 MIN.	0.6+0.00 -0.40	6.40±0.20	5.20±0.20	2.10±0.20
Application	A	H	T1	C	d	D	W	E1	F
TSSOP-8	330.0±2.00	50 MIN.	12.4+2.00 -0.00	13.0+0.50 -0.20	1.5 MIN.	20.2 MIN.	12.0±0.30	1.75±0.10	5.5±0.10
	P0	P1	P2	D0	D1	T	A0	B0	K0
	4.00±0.10	8.00±0.10	2.00±0.05	1.5+0.10 -0.00	1.5 MIN.	0.6+0.00 -0.40	6.90±0.20	3.40±0.20	1.60±0.20

(mm)

Devices Per Unit

Package Type	Unit	Quantity
SOP-8	Tape & Reel	2500
TSSOP-8	Tape & Reel	2500

Reflow Condition (IR/Convection or VPR Reflow)



Reliability Test Program

Test item	Method	Description
SOLDERABILITY	MIL-STD-883D-2003	245°C, 5 sec
HOLT	MIL-STD-883D-1005.7	1000 Hrs Bias @125°C
PCT	JESD-22-B, A102	168 Hrs, 100%RH, 121°C
TST	MIL-STD-883D-1011.9	-65°C~150°C, 200 Cycles
ESD	MIL-STD-883D-3015.7	VHBM > 2KV, VMM > 200V
Latch-Up	JESD 78	10ms, I_{tr} > 100mA

Classification Reflow Profiles

Profile Feature	Sn-Pb Eutectic Assembly	Pb-Free Assembly
Average ramp-up rate (T_L to T_P)	3°C/second max.	3°C/second max.
Preheat - Temperature Min (T_{smin}) - Temperature Max (T_{smax}) - Time (min to max) (t_s)	100°C 150°C 60-120 seconds	150°C 200°C 60-180 seconds
Time maintained above: - Temperature (T_L) - Time (t_L)	183°C 60-150 seconds	217°C 60-150 seconds
Peak/Classification Temperature (T_P)	See table 1	See table 2
Time within 5°C of actual Peak Temperature (t_p)	10-30 seconds	20-40 seconds
Ramp-down Rate	6°C/second max.	6°C/second max.
Time 25°C to Peak Temperature	6 minutes max.	8 minutes max.

Note: All temperatures refer to topside of the package. Measured on the body surface.

Classification Reflow Profiles (Cont.)

Table 1. SnPb Eutectic Process – Package Peak Reflow Temperatures

Package Thickness	Volume mm ³ <350	Volume mm ³ ≥350
<2.5 mm	240 +0/-5°C	225 +0/-5°C
≥2.5 mm	225 +0/-5°C	225 +0/-5°C

Table 2. Pb-free Process – Package Classification Reflow Temperatures

Package Thickness	Volume mm ³ <350	Volume mm ³ 350-2000	Volume mm ³ >2000
<1.6 mm	260 +0°C*	260 +0°C*	260 +0°C*
1.6 mm – 2.5 mm	260 +0°C*	250 +0°C*	245 +0°C*
≥2.5 mm	250 +0°C*	245 +0°C*	245 +0°C*

*Tolerance: The device manufacturer/supplier **shall** assure process compatibility up to and including the stated classification temperature (this means Peak reflow temperature +0°C. For example 260°C+0°C) at the rated MSL level.

Customer Service